

**NPN Silicon RF Transistor**

- For amplifier and oscillator applications in TV-tuners
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101



**ESD (Electrostatic discharge) sensitive device, observe handling precaution!**

Type	Marking	Pin Configuration			Package
BF517	LRs	1 = B	2 = E	3 = C	SOT23

**Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CEO}$	15	V
Collector-base voltage	$V_{CBO}$	25	
Emitter-base voltage	$V_{EBO}$	2.5	
Collector current	$I_C$	25	mA
Peak collector current	$I_{CM}$	50	
Total power dissipation <sup>2)</sup> $T_S \leq 55 \text{ }^\circ\text{C}$	$P_{tot}$	280	mW
Junction temperature	$T_j$	150	$^\circ\text{C}$
Ambient temperature	$T_A$	-65 ... 150	
Storage temperature	$T_{stg}$	-65 ... 150	

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>3)</sup>	$R_{thJS}$	$\leq 340$	K/W

<sup>1)</sup>Pb-containing package may be available upon special request

<sup>2)</sup> $T_S$  is measured on the collector lead at the soldering point to the pcb

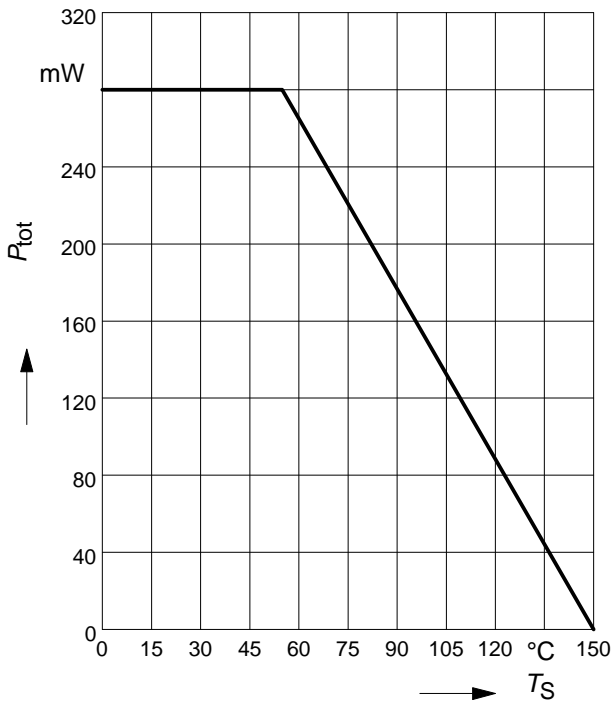
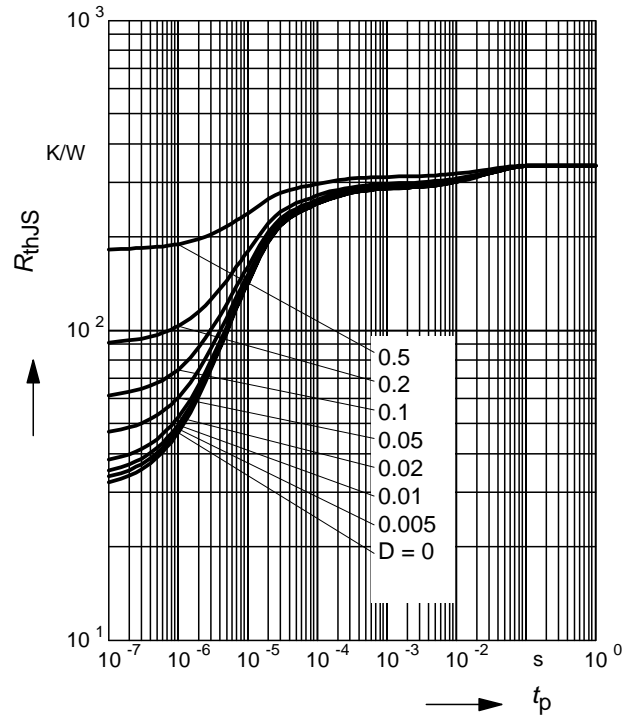
<sup>3)</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

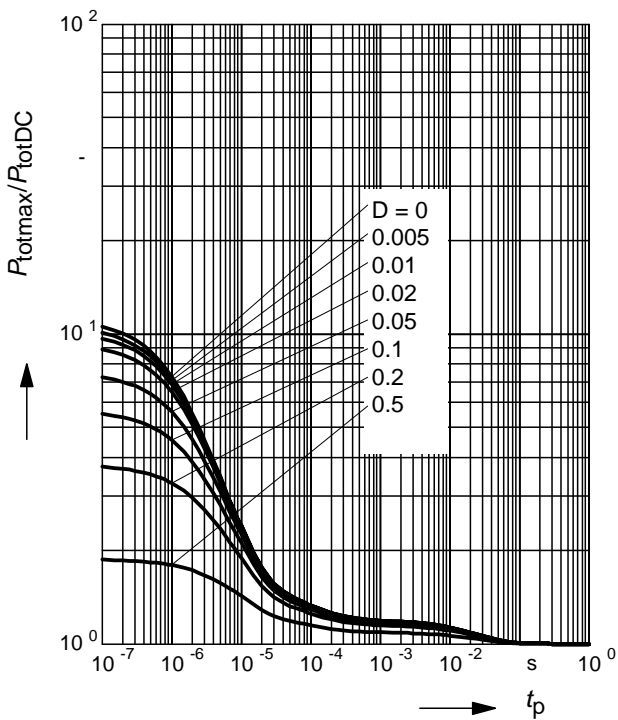
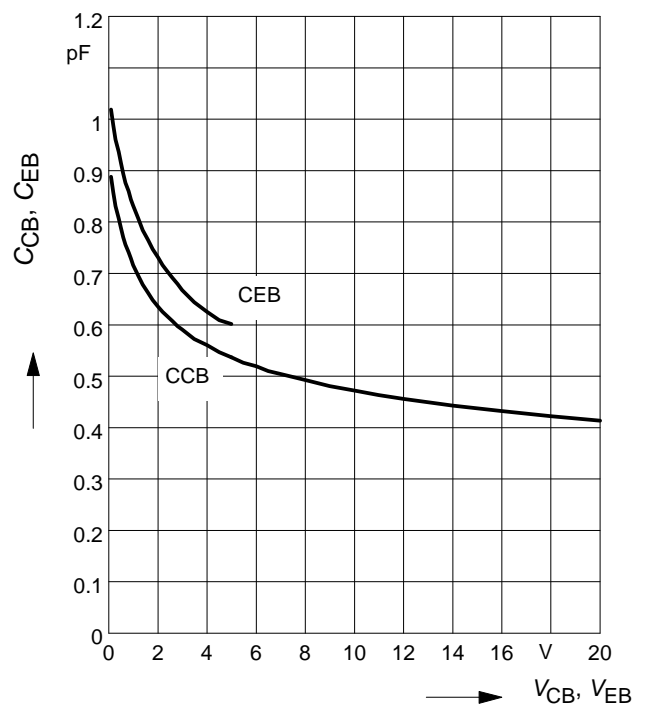
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(BR)CEO}$	15	-	-	V
Collector-base cutoff current $V_{CB} = 10 \text{ V}, I_E = 0$ $V_{CB} = 25 \text{ V}, I_E = 0$	$I_{CBO}$	-	-	0.05 10	$\mu\text{A}$
Emitter-base cutoff current $V_{EB} = 2.5 \text{ V}, I_C = 0$	$I_{EBO}$	-	-	100	
DC current gain- $I_C = 2 \text{ mA}, V_{CE} = 1 \text{ V}, \text{ pulse measured}$ $I_C = 25 \text{ mA}, V_{CE} = 1 \text{ V}, \text{ pulse measured}$	$h_{FE}$	40 20	- 70	150 -	-
Collector-emitter saturation voltage $I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$	$V_{CEsat}$	-	0.1	0.4	V

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b> (verified by random sampling)					
Transition frequency $I_C = 2\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $f = 200\text{ MHz}$ $I_C = 25\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $f = 200\text{ MHz}$	$f_T$	1 1.3	1.4 2.5	- -	GHz
Collector-base capacitance $V_{CB} = 5\text{ V}$ , $f = 1\text{ MHz}$ , $V_{BE} = 0$ , emitter grounded	$C_{cb}$	-	0.55	0.8	pF
Collector emitter capacitance $V_{CE} = 5\text{ V}$ , $f = 1\text{ MHz}$ , $V_{BE} = 0$ , base grounded	$C_{ce}$	-	0.27	-	
Emitter-base capacitance $V_{EB} = 0.5\text{ V}$ , $f = 1\text{ MHz}$ , $V_{CB} = 0$ , collector grounded	$C_{eb}$	-	0.9	1.45	
Noise figure $I_C = 2\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $Z_S = 50\ \Omega$ , $f = 800\text{ MHz}$	$F$	-	3.5	5	dB
Transducer gain $I_C = 20\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $Z_S = Z_L = 50\ \Omega$ , $f = 500\text{ MHz}$	$ S_{21e} ^2$	-	13	-	dB
Third order intercept point at output $V_{CE} = 5\text{ V}$ , $I_C = 20\text{ mA}$ , $f = 800\text{ MHz}$ , $Z_S = Z_{Sopt}$ , $Z_L = Z_{Lopt}$	$IP_3$	-	21.5	-	dBm
1dB Compression point $I_C = 20\text{ mA}$ , $V_{CE} = 5\text{ V}$ , $Z_S = Z_L = 50\ \Omega$ , $f = 800\text{ MHz}$	$P_{-1dB}$	-	10	-	-

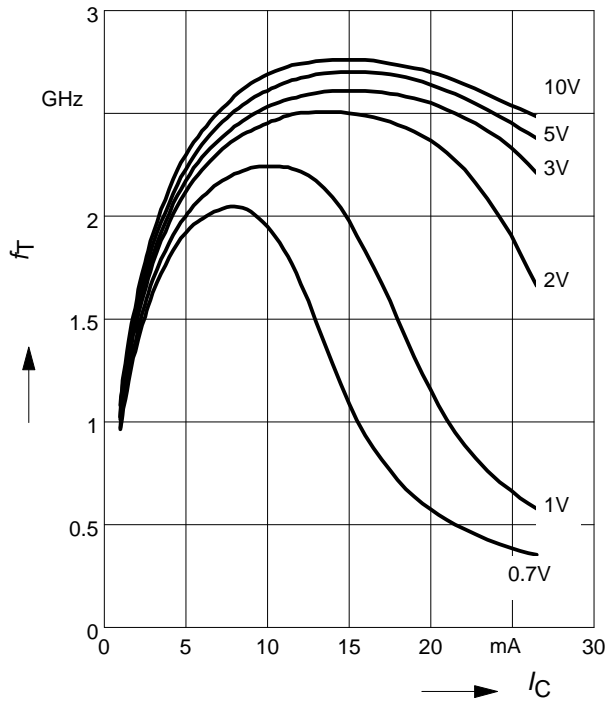
**Total power dissipation  $P_{tot} = f(T_S)$** 

**Permissible Pulse Load  $R_{thJS} = f(t_p)$** 

**Permissible Pulse Load**

$$P_{totmax}/P_{totDC} = f(t_p)$$

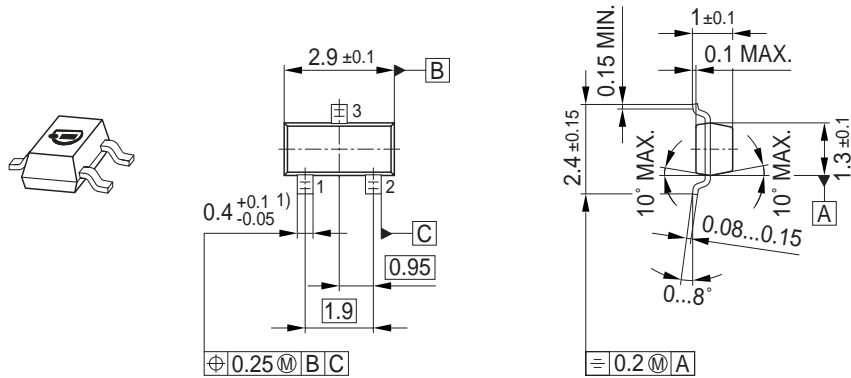

**Collector-base capacitance  $C_{cb} = f(V_{CB})$** 
**Emitter-base capacitance  $C_{eb} = f(V_{EB})$** 
 $f = 1 \text{ MHz}$ 


Transition frequency  $f_T = f(I_C)$

$V_{CE}$  = parameter

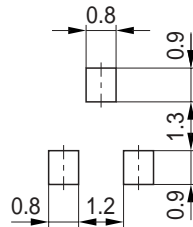


Package Outline

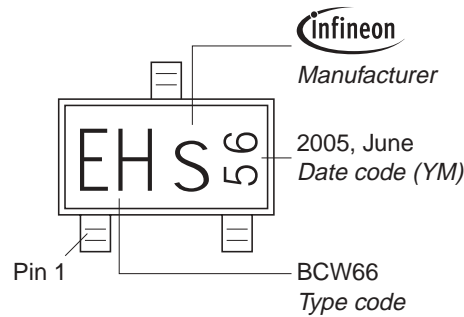


1) Lead width can be 0.6 max. in dambar area

Foot Print

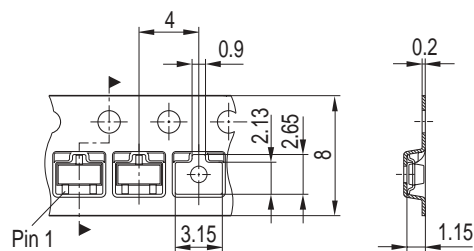


Marking Layout (Example)



Standard Packing

Reel  $\varnothing$ 180 mm = 3.000 Pieces/Reel  
 Reel  $\varnothing$ 330 mm = 10.000 Pieces/Reel



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